PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT3835128

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ASHUTOSH AGGARWAL	08/14/2015
MATTHEW DANIEL SMITH	03/30/2016
AARON MICHAEL PULLIAM	06/24/2015
CLIFTON SCOTT	07/14/2015

RECEIVING PARTY DATA

Name:	QUALCOMM CONNECTED EXPERIENCES, INC.
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	14698453
Application Number:	62002710

CORRESPONDENCE DATA

Fax Number: (720)536-4910

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 720.536.4900

Email: rene@nodiplaw.com

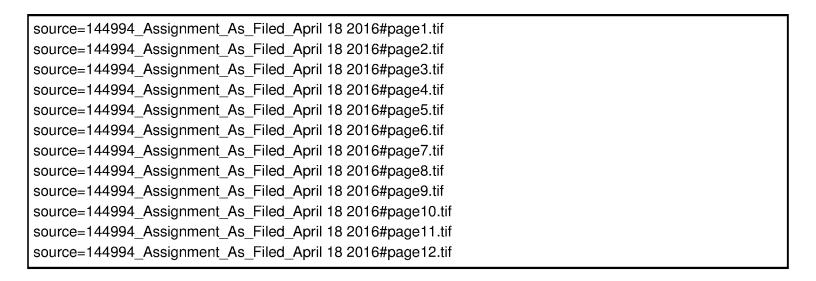
Correspondent Name: NEUGEBOREN O'DOWD PC Address Line 1: 1227 SPRUCE STREET

SUITE 200 Address Line 2:

Address Line 4: **BOULDER, COLORADO 80302**

ATTORNEY DOCKET NUMBER:	144994 144994P1
NAME OF SUBMITTER:	SEAN R. O'DOWD
SIGNATURE:	/Sean R. O'Dowd/
DATE SIGNED:	04/18/2016
	·

Total Attachments: 12



WHEREAS, WE,

- 1. Ashutosh Aggarwal, a citizen of the United States of America (US), having a mailing address located at Qualcomm Incorporated, 5775 Morehouse Dr., San Diego, CA 92121, and a resident of San Diego, CA,
- 2. **Matthew Daniel Smith**, a citizen of the United States of America (US), having a mailing address located at Qualcomm Incorporated, 5775 Morehouse Dr., San Diego, CA 92121, and a resident of San Jose, CA,
- 3. Aaron Michael Pulliam, a citizen of the United States of America (US), having a mailing address located at Qualcomm Incorporated, 5775 Morehouse Dr., San Diego, CA 92121, and a resident of Poway, CA,
- 4. **Clifton Scott**, a citizen of the United States of America (US), having a mailing address located at Qualcomm Incorporated, 5775 Morehouse Dr., San Diego, CA 92121, and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to IMPROVING MULTICAST PACKET RECEPTION RELIABILITY OVER WI-FI (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, Qualcomm Connected Experiences, Inc. (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s), 14/698,453 filed April 28, 2015, Qualcomm Reference No. 144994, and all provisional applications relating thereto, together with U.S. Provisional Application No(s), 62/002,710, filed May 23, 2014, Qualcomm Reference No. 144994P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications,

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	Sanniedn	.on	S/14/s	Aug.
	LOCATION	erage (1000) in the contract of	DATE	Ashutosh Aggarwal
Done at	LOCATION	, on		
	LOCATION		DATE	Matthew Daniel Smith
Done at	LOCATION	-> on	DATE	Aaron Michael Pulliam
Done at		on		
	LOCATION		DATE	Clifton Scott

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Done at	, O	l .	No. 1995 April 1
	LOCATION	DATE	Ashutosh Aggarwal
Done at <u></u>	CA PALOALIO, OI LOCATION	n <u>3 90 2016</u> Date	Matthew Daniel Smith
Done at	EOCATION	DATE	Aaron Michael Pulliam
Done at _	, OI) Date	Cliffon Scoti

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LOCATION	DATE	Ashniosh Aggarwal
Done at	, on	
LOCATION	DATE	Matthew Daniel Smith
Done at Silve Done it	A_, on	1. V
LOCATION	DATE	Aaron Michael Pulliam
Done at	ón	
LOCATION	DATE	Clifton Scott

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Done at		, 011	243.355.00.05
52.000	LOCATION	DATE	Ashutosh Aggarwal
Done at	LOCATION	, on	Matthew Daniel Smith
Done at	LOCATION	, OB	Aaron Michael Pulliam
<u> </u>		-1.1.	ANA MA
Done at	LOCATION	, on <u>// 7//)</u> DATE	Clifton Scott
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PATENT REEL: 038459 FRAME: 0788

RECORDED: 04/18/2016